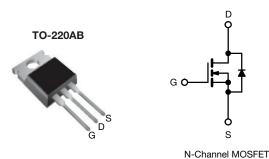


E Series Power MOSFET



PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	650)		
$R_{DS(on)}$ typ. (Ω) at 25 °C	V _{GS} = 10 V	0.269		
Q _g max. (nC)	64			
Q _{gs} (nC)	8			
Q _{gd} (nC)	_{gd} (nC) 13			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Load (Dh) free and halogen free	SiHP14N60E-BE3 a
Lead (Pb)-free and halogen-free	SiHP14N60E-GE3

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, ur	less otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600	
Gate-source voltage		V_{GS}	± 30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous drain current (T _{.I} = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		13	
Continuous drain current (1 _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	8	A W/°C mJ W °C V/ns
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				1.2	W/°C
Single pulse avalanche energy b		E _{AS}	136	mJ	
Maximum power dissipation			P_{D}	147	W
Operating junction and storage temperature range	ge		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J =	T _J = 125 °C		70	\//no
Reverse diode dV/dt ^d			dV/dt	32	V/IIS
Soldering recommendations (peak temperature) c For 10 s		r 10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_q = 25 \,\Omega$, $I_{AS} = 3.1 \,\text{A}$
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.85	G/ VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.73	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Onto anima lankana		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
7		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 7 A	-	0.269	0.309	Ω
Forward transconductance	9 _{fs}	V_{DS}	= 30 V, I _D = 7 A	-	3.8	-	S
Dynamic		+		•	•		•
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	1205	-	pF
Output capacitance	C _{oss}	,	V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz		62	-	
Reverse transfer capacitance	C _{rss}				5	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	52	-	
Effective output capacitance, time related ^b	$C_{o(tr)}$	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		177	-	
Total gate charge	Qg			-	32	64	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 7 A, V_{DS} = 480 V$	-	8	-	nC
Gate-drain charge	Q _{gd}			-	13	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 7 A,		-	15	30	ns
Rise time	t _r			-	19	38	
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		35	70	
Fall time	t _f				15	30	
Gate input resistance	R _g	f = 1 MHz, open drain		0.38	0.75	1.5	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	13	
Pulsed diode forward current	I _{SM}			-	-	32	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	281	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25$ °C, $I_F = I_S = 7$ A, $dI/dt = 100$ A/ μ s, $V_R = 25$ V		-	3.4	-	μC
Reverse recovery current	I _{RRM}			_	22	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

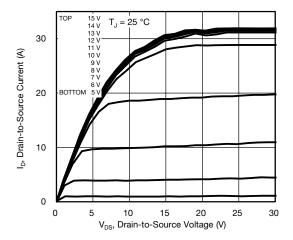


Fig. 1 - Typical Output Characteristics

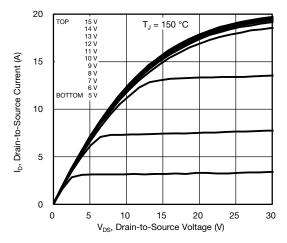


Fig. 2 - Typical Output Characteristics

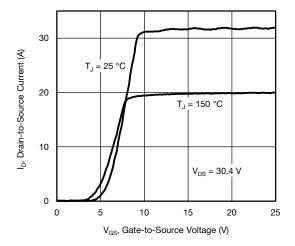


Fig. 3 - Typical Transfer Characteristics

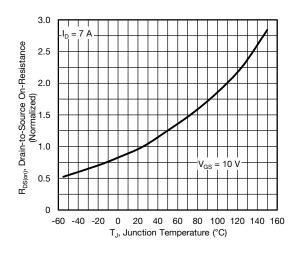


Fig. 4 - Normalized On-Resistance vs. Temperature

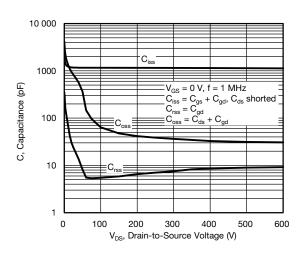


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

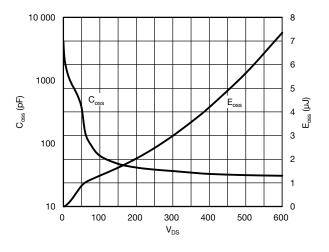


Fig. 6 - Coss and Eoss vs. VDS



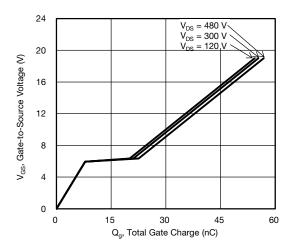


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

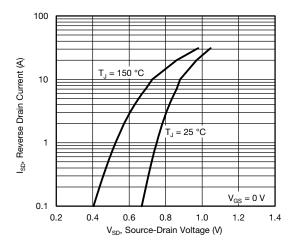


Fig. 8 - Typical Source-Drain Diode Forward Voltage

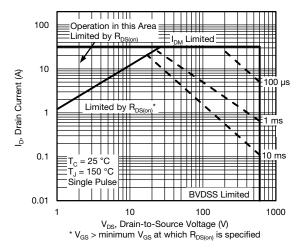


Fig. 9 - Maximum Safe Operating Area

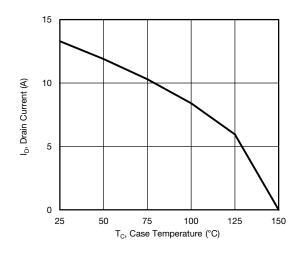


Fig. 10 - Maximum Drain Current vs. Case Temperature

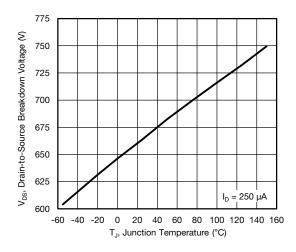


Fig. 11 - Temperature vs. Drain-to-Source Voltage



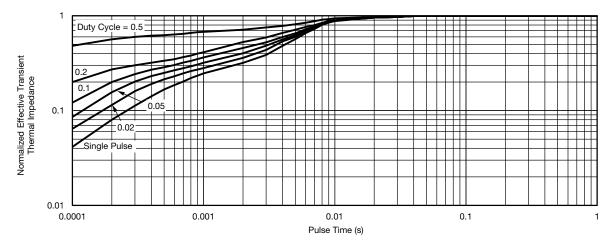


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

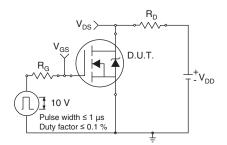


Fig. 13 - Switching Time Test Circuit

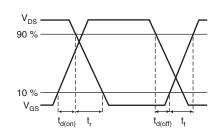


Fig. 14 - Switching Time Waveforms

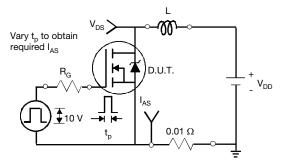


Fig. 15 - Unclamped Inductive Test Circuit

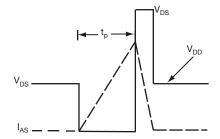


Fig. 16 - Unclamped Inductive Waveforms

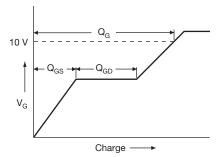


Fig. 17 - Basic Gate Charge Waveform

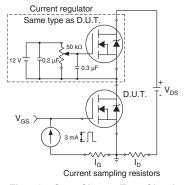
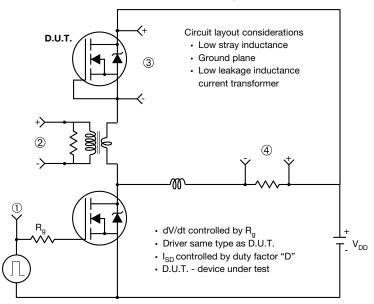


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



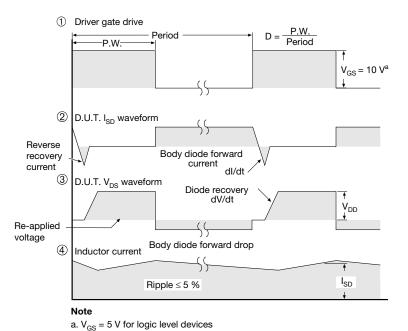
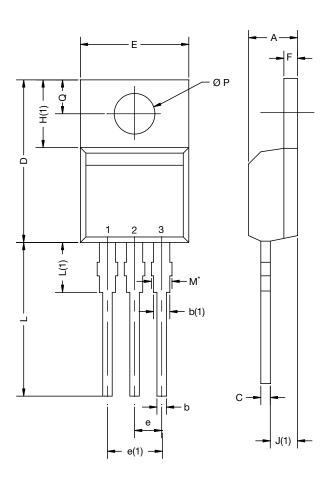


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIM	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

DWG: 6031

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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